

2.0x1.25mm SMD CHIP LED LAMP



ATTENTION

OBSERVE PRECAUTIONS FOR HANDLING ELECTROSTATIC DISCHARGE SENSITIVE **DEVICES**

Part Number: APHBM2012PBASURKC

Blue Hyper Red

Features

- 2.0mmx1.25mm SMT LED, 0.45mm max. thickness.
- Bi -color, low power consumption.
- Wide viewing angle.
- Ideal for backlight and indicator.
- Package : 2000pcs / reel.
- Moisture sensitivity level : level 3.
- RoHS compliant.

Description

The Blue source color devices are made with InGaN on SiC Light Emitting Diode.

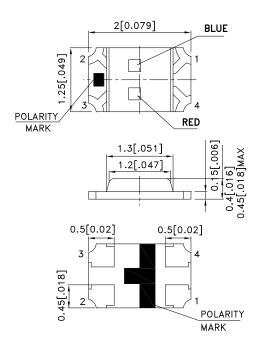
The Hyper Red source color devices are made with Al-GaInP on GaAs substrate Light Emitting Diode.

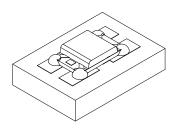
Static electricity and surge damage the LEDS.

It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs.

All devices, equipment and machinery must be electrically grounded.

Package Dimensions





- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ±0.1(0.004") unless otherwise noted.
- Specifications are subject to change without notice.
 The device has a single mounting surface. The device must be mounted according to the specifications.





SPEC NO: DSAG7624 APPROVED: WYNEC

REV NO: V.3

CHECKED: Allen Liu

DATE: MAR/26/2009 DRAWN: D.M.Su

PAGE: 1 OF 6 ERP: 1203005980

Selection Guide

Part No.	Dice	Lens Type	lv (mcd) [2] @ 20mA		Viewing Angle [1]
		-	Min.	Тур.	201/2
APHBM2012PBASURKC	Blue (InGaN)	WATER CLEAR	18	50	120°
	Hyper Red (AlGaInP)	WATER CLEAR	70	220	

- 1. 01/2 is the angle from optical centerline where the luminous intensity is 1/2 the optical centerline value.
 2. Luminous intensity/ luminous Flux: +/-15%.

Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Blue Hyper Red	468 650		nm	Ir=20mA
λD [1]	Dominant Wavelength	Blue Hyper Red	470 630		nm	Ir=20mA
Δλ1/2	Spectral Line Half-width	Blue Hyper Red	21 28		nm	Ir=20mA
С	Capacitance	Blue Hyper Red	100 35		pF	VF=0V;f=1MHz
VF [2]	Forward Voltage	Blue Hyper Red	3.2 1.95	4 2.5	V	Ir=20mA
lR	Reverse Current	Blue Hyper Red		10 10	uA	V _R = 5V

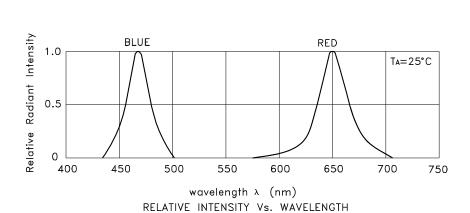
- 1.Wavelength: +/-1nm. 2. Forward Voltage: +/-0.1V.

Absolute Maximum Ratings at TA=25°C

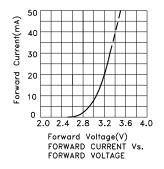
Parameter	Blue	Hyper Red	Units		
Power dissipation	120	75	mW		
DC Forward Current	30	30	mA		
Peak Forward Current [1]	100	185	mA		
Reverse Voltage		V			
Operating Temperature	-40°C To +85°C				
Storage Temperature	-40°C To +85°C				

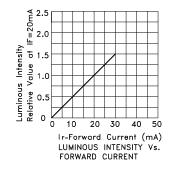
Note: 1. 1/10 Duty Cycle, 0.1ms Pulse Width.

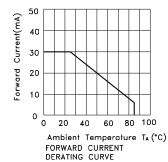
SPEC NO: DSAG7624 REV NO: V.3 DATE: MAR/26/2009 PAGE: 2 OF 6 APPROVED: WYNEC CHECKED: Allen Liu DRAWN: D.M.Su ERP: 1203005980

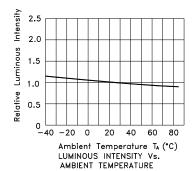


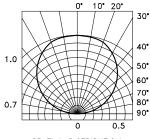
APHBM2012PBASURKC **Blue**









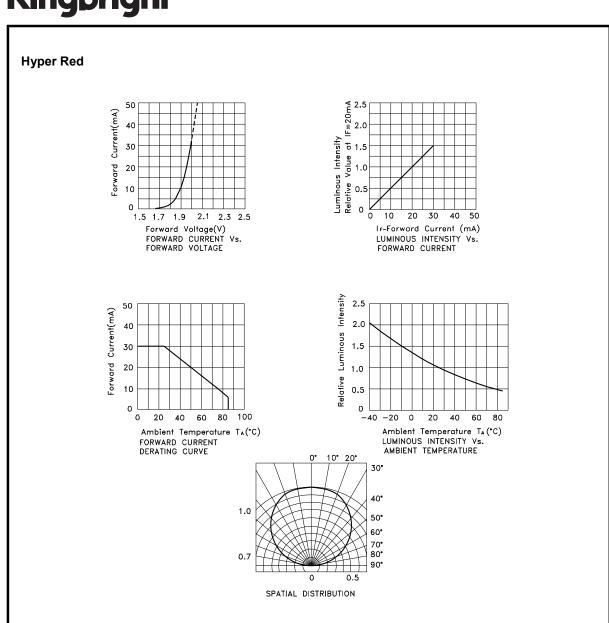


SPATIAL DISTRIBUTION

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PAGE: 3 OF 6 ERP: 1203005980



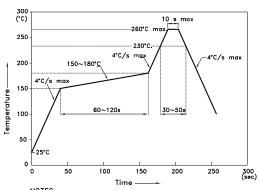
 SPEC NO: DSAG7624
 REV NO: V.3
 DATE: MAR/26/2009
 PAGE: 4 OF 6

 APPROVED: WYNEC
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 ERP: 1203005980

APHBM2012PBASURKC

Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

Reflow Soldering Profile For Lead-free SMT Process.



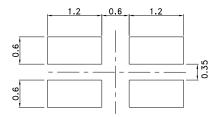
NOTES:

1.We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C.

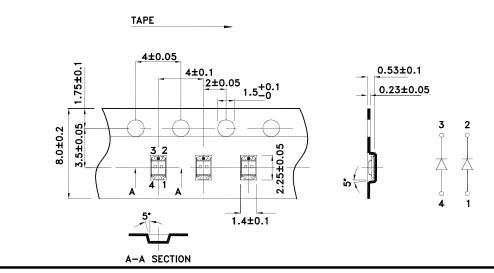
2.Don't cause stress to the epoxy resin while it is exposed to high temperature.

3.Number of reflow process shall be 2 times or less.

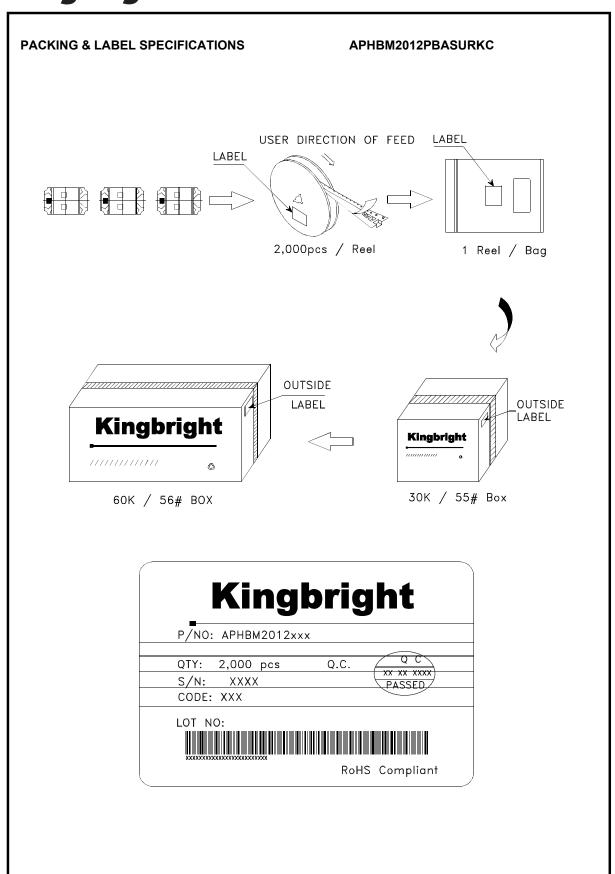
Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)



Tape Dimensions (Units : mm)



SPEC NO: DSAG7624 APPROVED: WYNEC REV NO: V.3 CHECKED: Allen Liu DATE: MAR/26/2009 DRAWN: D.M.Su PAGE: 5 OF 6 ERP: 1203005980



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